| Sheet 1 of 1 INFORMATION DISCLOSURE STATEMENT | | | | | | | | | | |
|--|--|--|------|------------------------------------|-------|----------|-------|------------------------------|-------------------------------|--|
| FORM PTO/SB/08 A&B (modified) | | | | ATTY DOCKET NO. 2003_1187A | | | | SERIAL NO. 10/644,738 | | |
| U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | | | APPLICANT Tsuyoshi NAKAMURA et al. | | | | | | |
| LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary) | | | | FILING DATE | | | GROUP | | | |
| Date Submitted to PTO: March 22, 2011 | | | | August 21, 2003 | | | 1795 | 1795 | | |
| ************************************** | U.S. PATENT DOCUMENTS | | | | | | | | | |
| *EXAMINER INITIAL | <u> </u> | DOCUMENT NUMBER | DATE | NAME | | | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE | |
| | AA | | | | | | | | | |
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| | FOREIGN PATENT DOCUMENTS | | | | | | | | | |
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| | ВВ | | | | | | | | | |
| | ВС | | | | | | | | | |
| | BD | | | | | | | | | |
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